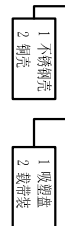


- NOTES:
- 1.MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC
UL94V_0,COLOR:BLACK.
CONTACT: COPPER ALLOYS.
COVER: COPPER ALLOYS OR STEEL.
 - 2.PLATING:
UNDERPLATE: NICKEL.
CONTACT AREA: GOLD OVER NICKEL.
SOLDER AREA: TIN OVER NICKEL.
 - 3.MULTIMEDIA CARD COMPATIBLE

定订须知: SDP1X-S1S1-1000-A



UNITS	mm	PART NO.(INTENDED USE)		TITLE:	
MAT'L		SDP1X-S1S1-X000-A		SD PUSH卡座	
		FINISH		DWG NO.:	
X± 0.3	X²± 5'	APPD:		FP-090015	
X± 0.25	X²± 2'	CHKD:		SCALE	
XX± 0.20	XX²± 1'	DR: HU 2016.09.28		1/1	
XXX± 0.10	XXX²± 0.5'	Q'TY		SHEET	
		PCS		1/1	
				REV.	
				A	

mstconn 深圳市德瑞电子有限公司
SHENZHEN DERUI ELECTRONIC CO., LTD.